

MCAL_AM263_10.02.00 Release Notes

MCAL Release Notes

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Introduction

This is the release notes for **MCAL_AM263_10.02.00 (Early Adaptor)** release for CMPSS, PWM XBAR (MCU) and Output XBAR (MCU) drivers, done on 28-Mar-2025.

Note: This is early adaptor patch release to enable customer with above modules. Customer need to migrate to the official 10.02.00 release when it is available.

The MCAL package consists of MCAL Driver & Applications for **AM263x family of devices**. The MCAL modules are compliant to AUTOSAR specification versioned **4.3.1**.

Licensing

Refer to AM263x manifest at top level for MCAL_AM263_10.02.00_manifest.html

Getting Started

The AM263x [[HTML](#)] User Guide provides the documentation and references necessary to begin development on TI's platforms using AM263x.

Datasheet

The AM263x [[HTML](#)] User Guide provides the Memory footprint details.

Documentation

The AM263x [[HTML](#)] User Guide provides the documentation and references necessary to begin development on TI's platforms using AM263x.

This document details about supported driver, installation, dependencies, build instructions, steps to run example applications. This release package also includes module specific User Guides, test reports, configurator User Guide and others.

Dependencies

NA

What's New

1. New in this Release:
 - CDD for CMPSS
 - MCU: PWM XBAR and Output XBAR
2. Full functional testing performed for CMPSS, PWM XBAR and Output XBAR modules and for other modules only BFT (Basic Sanity Test) done
3. Drivers Supported:

Drivers	Modules
Micro controller Drivers	GPT, WDG, MCU (+ PWM XBAR, Output XBAR)
Memory Driver	FLS
Communication Driver	SPI, CAN, ETH, ETHTRCV, LIN
I/O Drivers	ADC, DIO, PORT, PWM, ICU
CDD	IPC, UART, I2C, DMA, FSI, PWM, CMPSS

Device Support

SoC	HOST (OS)	Target (OS)	Supported CPU	Test Platform
AM263x	Windows / Linux, EB configurator only on Windows	Baremetal	R5F	AM263x

Tools and Compilers

1. Code Composer Studio: 12.5.0 or later.
2. TI ARM CLANG Compiler Version: 4.0.0
3. Elektrobit Tresos Studio: 29.3 ([EB_Tresos_ACG8.8.10_Installer.zip](#)). Please use link to request access to EB Tresos Studio and License: [Click Here](#)

Compatibility

Driver	Compatibility Information	Comments	Recommended update for Customer Application
NA	NA	NA	NA

*Internal Files are organized in V0, V1, V2 and V3 folders. The below table lists the associated V0/V1/V2/V3 files to be used as per device.

#	Modules	AM263x	AM273	AM263Px	AM261x
1.	ADC	V0	V1	V0	V0
2.	CAN	V0	V0	V0	V0
3.	CDD I2C	V0	V0	V0	V0
4.	CDD IPC	V0	V1	V0	V2
5.	CDD UART	V0	V1	V0	V0
6.	CDD DMA	V0	V1	V0	V0
7.	CDD PWM	V0	NA	V0	NA
8.	DIO	V0	V1	V0	V0
9.	ETH	V0	V1	V0	NA
10.	ETHTRCV	V0	V1	V0	NA
11.	FLS	V0	V1	V2	V2
12.	FSI	V0	NA	V0	NA
13.	GPT	V0	V0	V0	V0
14.	ICU	V0	V1	V0	V0
15.	LIN	V0	NA	V0	NA
16.	MCU	V0	V1	V2	V3
17.	PORT	V0	V1	V0	V0

18.	PWM	V0	V1	V0	V0
19.	SPI	V0	V1	V0	V0
20.	WDG	V0	V0	V0	V0

Validation

Examples are validated with SBL Prebuilt binary of MCU+SDK 10.01.00 available at ti.com

#	Module	Validation Scope	Remarks (Refer to <i>Open Defects</i> for details)
1.	ADC	Unit Functional Testing and Code Coverage	None
2.	CAN	Unit Functional Testing and Code Coverage	None
3.	CDD FSI	Unit Functional Testing	None
4.	CDD I2C	Unit Functional Testing and Code Coverage	None
5.	CDD IPC	Unit Functional Testing and Code Coverage	None
6.	CDD UART	Unit Functional Testing and Code Coverage	None
7.	CDD PWM	Unit Functional Testing and Code Coverage	None
8.	DIO	Unit Functional Testing and Code Coverage	None

9.	DMA	Unit Functional Testing and Code Coverage	None
10.	ETH	Unit Functional Testing	ETH is not tested on RMII mode because of the limitation in current ETHTRCV, as it won't support RMII mode.
11.	ETHTRCV	Unit Functional Testing	None
12.	FLS	Unit Functional Testing and Code Coverage	None
13.	GPT	Unit Functional Testing and Code Coverage	None
14.	ICU	Unit Functional Testing and Code Coverage	None
15.	MCU	Unit Functional Testing and Code Coverage	Reset Reason tested only for Power on Reset, SW Warm Reset and Watchdog reset
16.	PORT	Unit Functional Testing and Code Coverage	None
17.	PWM	Unit Functional Testing and Code Coverage	None
18.	SPI	Unit Functional Testing and Code Coverage	None

19.	WDG	Unit Functional Testing and Code Coverage	None
20.	LIN	Unit Functional Testing and Code Coverage	<p>Tested:</p> <ol style="list-style-type: none"> 1. Internal sleep wakeup functionality. 2. Transmission types tested by connecting two simulated slaves on network: <ul style="list-style-type: none"> . Master Response . Slave Response . Slave to Slave <p>Not Tested:</p> <ol style="list-style-type: none"> 1. Network level sleep wakeup functionality
21	CDD CMPSS	Unit Functional Testing	None

Fixed Defects

ID	Summary
NA	NA

Open Defects

ID	Summary	Workaround
MCAL-27722	UART: Multiple UART instance are not working	Can use the instance configured
MCAL-27501	WDG: WDG doesn't follow SWS_Wdg_00140 completely	None
MCAL-25969	Connecting Multiple Interrupt sources to single Interrupt Xbar line is not supported	None
MCAL-24809	ETH: EcuM_cacheInvalidate and EcuM_cacheWbInv should not be included in Application side	None
MCAL-13434	SPI: Dma mode is not working with cache writeback enabled	Enable Cachewrite through mode
MCAL-11007	PWM: Unable to generate high resolution PWM waveform for non zero prescaler value in UP-Down count mode	None

Known Limitations

ID	Description	Workaround	Comments
NA	NA	NA	NA

Support

For technical support and additional assistance, visit [E2E](#) or contact local TI Field Application Engineer.

Versioning

Each package version is composed of 4 period-delimited numbers - represented here by the letters M, m, p and b [**M.m.p.b**]. The table below provides a descriptive reference regarding package version numbering.

Digit	Meaning	Description
1 (M =Major)	Major revision	Incremented when the new version is substantially different from the previous for example, a new module added or an existing modules algorithm significantly altered.
2 (m =minor)	Minor revision	Incremented when the new version has changed but not in a major way. For example, some minor changes in the API or feature set.
3 (p =patch)	Patch number	Incremented for all other source code changes. This includes any packaging support code.
4 (b =build)	Build number	Incremented for each release delivery to CM. Reset for any change to M, m or p

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